



LH1532FP/FPTR

Dual 1 Form A Solid State Relay

FEATURES

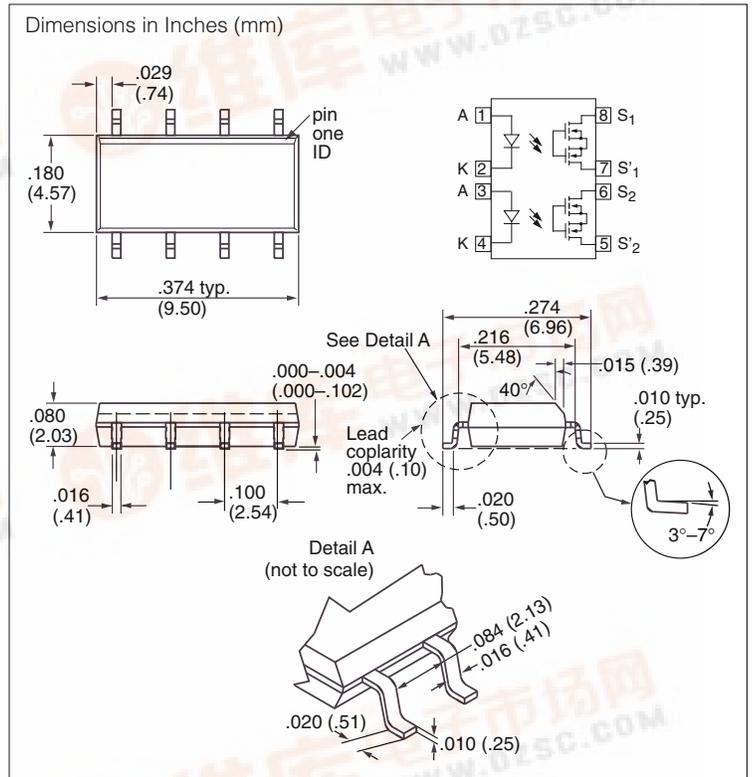
- Two Independent Relays in a Single Package
- Package—FLAT PAK
- I/O Isolation, 3000 V_{RMS}
- Solid-state Relay (Equivalent to AQW210S)
 - Typical R_{ON} 20 Ω
 - Load Voltage 350 V
 - Load Current 120 mA
 - Current Limit Protection
 - High Surge Capability
 - Linear, AC/DC Operation
 - Clean Bounce Free Switching
 - Low Power Consumption
 - High Reliability Monolithic Receptor

AGENCY APPROVALS

- UL – File No. E52744

APPLICATIONS

- General Telecom Switching
 - On/off Hook Control
 - Ring Relay
 - Ground Start
- Industrial Controls
 - Triac Predriver
 - Output Modules
- Peripherals
 - Transducer Driver
- Instrumentation
 - Automatic Tuning/Balancing
 - Flying Capacitor
 - Analog Multiplexing
- See Application Note 56



Part Identification

| Part Number | Description |
|-------------|--------------------------|
| LH1532FP | 8-pin SMD, Tubes |
| LH1532FPTR | 8-pin SMD, Tape and Reel |

DESCRIPTION

The LH1532FP is a Dual 1 Form A (SPST) which can replace electromechanical relays in many applications. They are constructed using a GaAlAs LED for activation control and an integrated monolithic die for the switch output. The die is comprised of a photodiode array, switch control circuitry and MOSFET switches. The SSR features low ON-resistance, high breakdown voltage and current-limit circuitry that protects the relay from telephone line induced lightning surges.

The LH1532FP comes in an 8 pin, 0.080 inch thick plastic Flat Pack: surface mount leads with 100 mil spacing.



Absolute Maximum Ratings, $T_A=25^\circ\text{C}$

Stresses in excess of the absolute Maximum Ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute Maximum Ratings for extended periods of time can adversely affect reliability.

Package

| | |
|--|-----------------------|
| Ambient Temperature Range | -40 to +85°C |
| Storage Temperature Range | -40 to +125°C |
| Soldering Temperature (t=10 s max.)..... | 260°C |
| Isolation Test Voltage (t=1.0 s) | 3000 V _{RMS} |
| Isolation Resistance | |
| $V_{IO}=500\text{ V}, T_A=25^\circ\text{C}$ | $\geq 1012\ \Omega$ |
| $V_{IO}=500\text{ V}, T_A=100^\circ\text{C}$ | $\geq 1011\ \Omega$ |
| Total Power Dissipation | 600 mW |

SSR

| | |
|---|--------|
| LED Continuous Forward Current | 50 mA |
| LED Reverse Voltage ($I_R \leq 10\ \mu\text{A}$)..... | 6.0 V |
| DC or Peak AC Load Voltage ($I_L \leq 50\ \mu\text{A}$) | 350 V |
| Continuous DC Load Current | 120 mA |

Electrical Characteristics, $T_A=25^\circ\text{C}$

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Condition |
|---|-------------|------|------|------|---------------|--|
| SSR | | | | | | |
| LED Forward Current for Switch Turn-on | I_{Fon} | — | 1.2 | 3.0 | mA | $I_L=100\text{ mA}, t=10\text{ ms}$ |
| LED Forward Current for Switch Turn-off | I_{Foff} | 0.2 | — | — | mA | $V_L=\pm 300\text{ V}$ |
| LED Forward Voltage | V_F | 1.0 | 1.22 | 1.5 | V | $I_F=10\text{ mA}$ |
| ON-Resistance | R_{ON} | — | 20 | 25 | Ω | $I_F=5\text{ mA}, I_L=\pm 50\text{ mA}$ |
| OFF-Resistance | R_{OFF} | — | 5000 | — | G Ω | $I_F=0\text{ mA}, V_L=\pm 100\text{ V}$ |
| Current Limit | I_{limit} | 170 | 210 | 250 | mA | $I_F=5.0\text{ mA}, t=5.0\text{ ms}$ |
| Output Off-state Leakage Current | — | — | 0.6 | 200 | nA | $I_F=0\text{ mA}, V_L=\pm 100\text{ V},$ |
| | — | — | — | 1.0 | μA | $I_F=0\text{ mA}, V_L=\pm 350\text{ V}$ |
| Output Capacitance | — | — | 55 | — | pF | $I_F=0\text{ mA}, V_L=1.0\text{ V}$ |
| Pole-to-pole Capacitance (S1 to S2) | — | — | 0.5 | — | pF | $I_F=5.0\text{ mA}$ |
| Turn-on Time | t_{on} | — | 1.1 | 2.5 | ms | $I_F=5.0\text{ mA}, I_L=50\text{ mA}$ |
| Turn-off Time | t_{off} | — | 0.06 | 2.5 | ms | $I_F=5.0\text{ mA}, I_L=50\text{ mA}$ |
| Switch Offset | — | — | 0.15 | — | μV | $I_F=5.0\text{ mA}$ |

Typical Performance Characteristics

Figure 1. LED Current for Switch Turn-on vs. Temperature

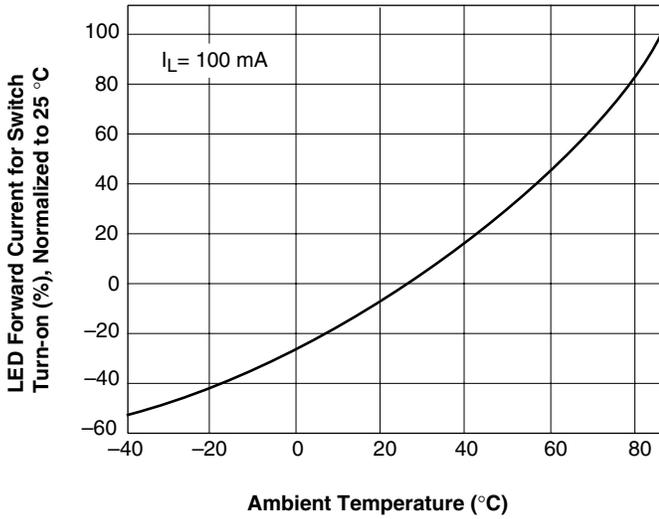


Figure 4. Switch Breakdown Voltage vs. Temperature

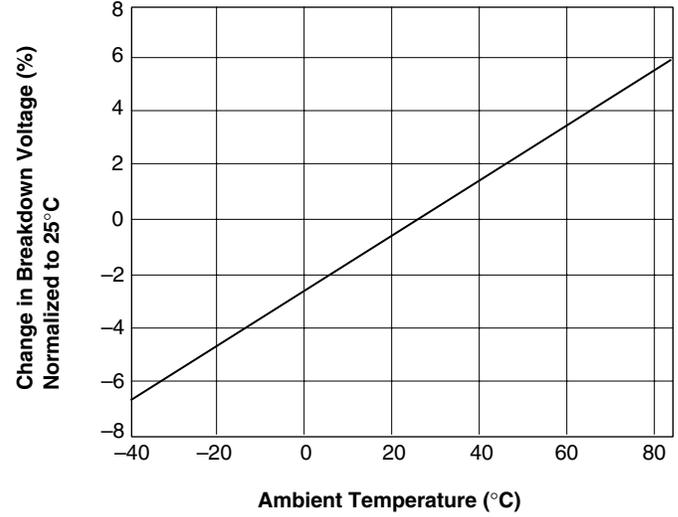


Figure 2. ON-Resistance vs. Temperature

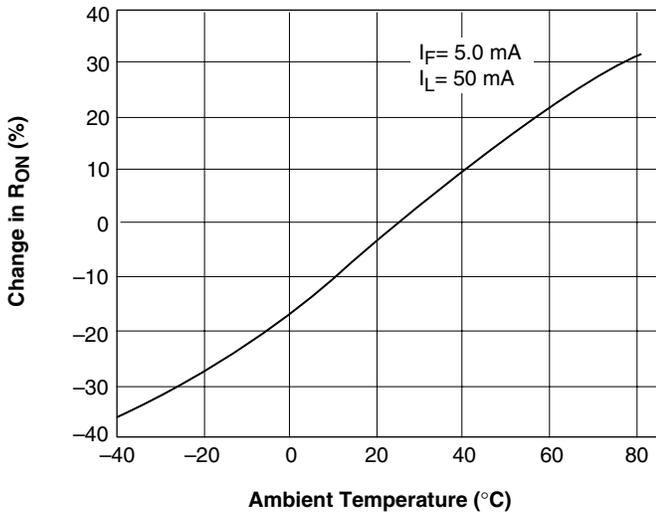


Figure 5. Switch Capacitance vs. Applied Voltage

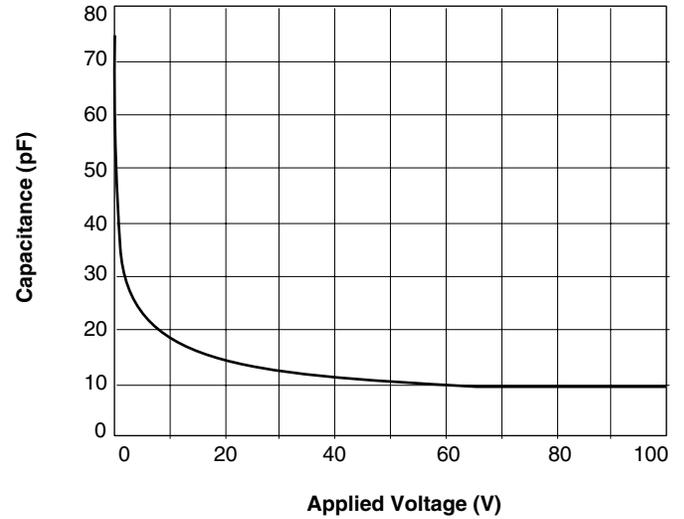


Figure 3. Current Limit vs. Temperature

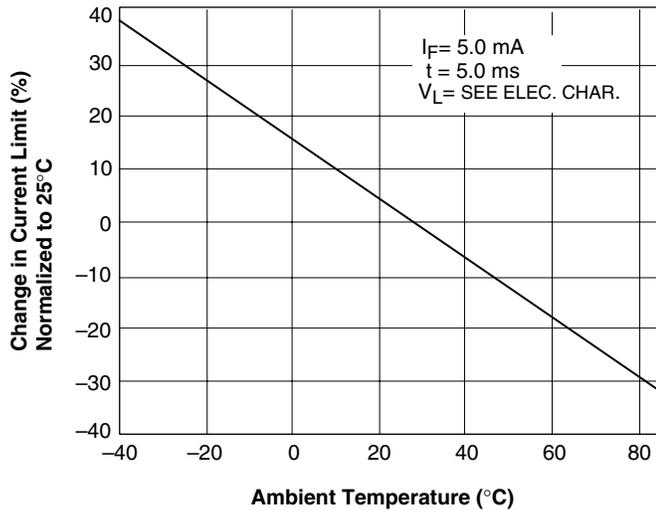


Figure 6. Leakage Current vs. Applied Voltage

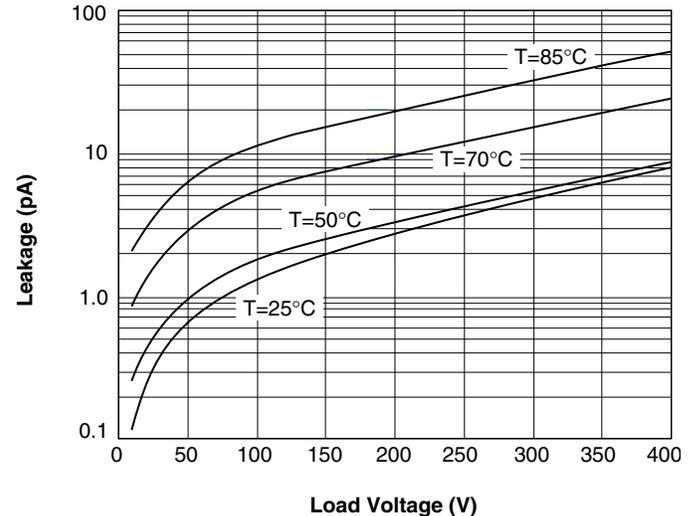


Figure 7. Leakage Current vs. Applied Voltage

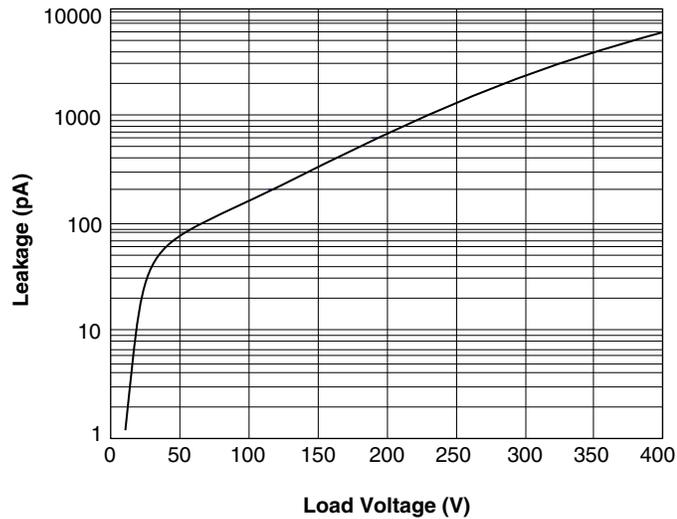


Figure 8. Turn-off Time vs. Temperature

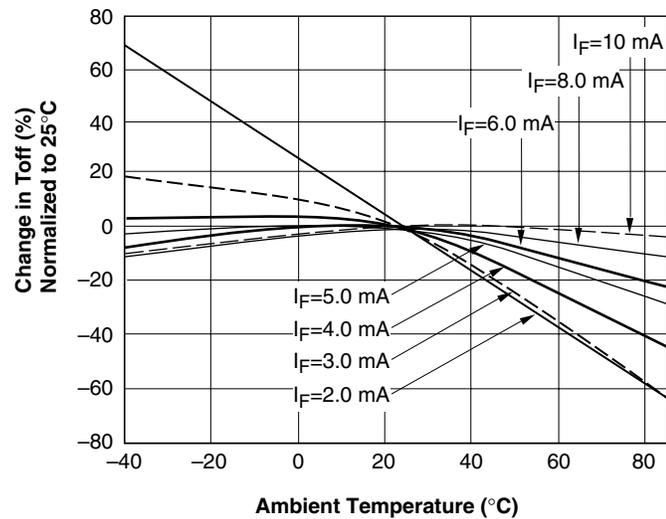


Figure 9. Turn-on Time vs. LED Current

